

**样机制作报告**

机型: 样机数量: 样机状态： 编号： .

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| 主送：研发部/产品部/DQM /生产部/品管部 |
|  |
| 一、相关文件及版本 |
| 二、物料使用情况（如：代料/缺料等） |

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| --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- | --- |
| 三、PCBA使用状态 | | | | | | | | | | | | | | |
| **文件问题** | | | | | | | | | | | | | | |
| **序号** | **检查项目** | | **物料编码/名称** | | **问题描述** | | | **临时措施** | | | | **长期措施** | | **解决进度** |
| 1 |  | |  | |  | | |  | | | |  | |  |
| 2 |  | |  | |  | | |  | | | |  | |  |
| 3 |  | |  | |  | | |  | | | |  | |  |
| 4 |  | |  | |  | | |  | | | |  | |  |
| **软件版本问题** | | | | | | | | | | | | | | |
| **序号** | **检查项目** | | **物料编码** | | | **问题描述** | **临时措施** | | **长期措施** | | | | | **解决进度** |
| 1 |  | | | | | | | | | | | | | |
| **SMD工艺问题** | | | | | | | | | | | | | | |
| **序号** | **检查项目** | | **物料编码/名称** | | | **问题描述** | | **图片** | | **长期措施** | | | | **解决进度** |
| **1** |  | | | | | | | | | | | | | |
| **后焊工艺问题** | | | | | | | | | | | | | | |
| **序号** | **检查项目** | | | **物料编码/名称** | | **问题描述** | **临时措施** | | **长期措施** | | | | | **解决进度** |
| **1** |  | | | | | | | | | | | | | |
| **测试问题** | | | | | | | | | | | | | | |
| **序号** | | **问题描述** | | | | | | **临时措施** | | | **长期措施** | | **解决进度** | |
| 1 | |  | | | | | |  | | |  | |  | |
| 2 | |  | | | | | |  | | |  | |  | |
| 3 | |  | | | | | |  | | |  | |  | |
| 4 | |  | | | | | |  | | |  | |  | |
| 5 | |  | | | | | |  | | |  | |  | |
| 6 | |  | | | | | |  | | |  | |  | |
| 7 | |  | | | | | |  | | |  | |  | |
| 8 | |  | | | | | |  | | |  | |  | |

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| 四、装配问题 | | | | | |
| **文件问题** | | | | | |
| **序号** | **物料编码/名称** | **问题描述** | **临时措施** | **长期措施** | **解决进度** |
| 1 |  |  |  |  |  |
| **装配问题** | | | | | |
| **序号** | **物料编码/名称** | **问题描述** | **临时措施** | **长期措施** | **解决进度** |
| 1 |  |  |  |  |  |
| 2 |  |  |  |  |  |
| 3 |  |  |  |  |  |
| 4 |  |  |  |  |  |
| 5 |  |  |  |  |  |

五、直通率与入库数量统计（包括PCBA测试、整机测试、组装）

5.1 各阶段直通率

|  |  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- | --- |
| **序号** | **物料编码** | **名称** | **板号** | **合格数量** | **总数量** | **直通率** |
| 1 |  |  |  |  |  |  |
| 2 |  |  |  |  |  |  |
| 3 |  |  |  |  |  |  |

5.2 试产数量入库信息

|  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- |
| 机型 | 中性数量 | PTN数量 | 客户数量 | **解决进度** | **备注** |
|  |  |  |  |  |  |

六、包装状态（填写包装方面出现的问题与出货包装的信息）

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| --- | --- | --- | --- | --- | --- |
| **包装信息资料（包装通用性确认）** | | | | | |
| **序号** | **物料编码/名称** | **问题描述** | **图片** | **长期措施** | **解决进度** |
| 1 |  | **无问题** |  |  |  |

七、重量信息

|  |  |  |  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- | --- | --- | --- |
| **序号** | **产品名称** | **净重（G）** | **毛重(G)** |  | **裸机尺寸(宽\*深\*高mm)** | **产品包装外尺寸(宽\*深\*高mm)** | **体积（CBM立方米）** | **备注** |
|  |  |  |  |  |  |  |  |  |

备注：净重专指裸机重量。

八、结果

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| 参会人员： | |
| 决议事项 | **本次试产的结论为：；。**  **本次试产的问题：** |

制作： 审核： 批准：